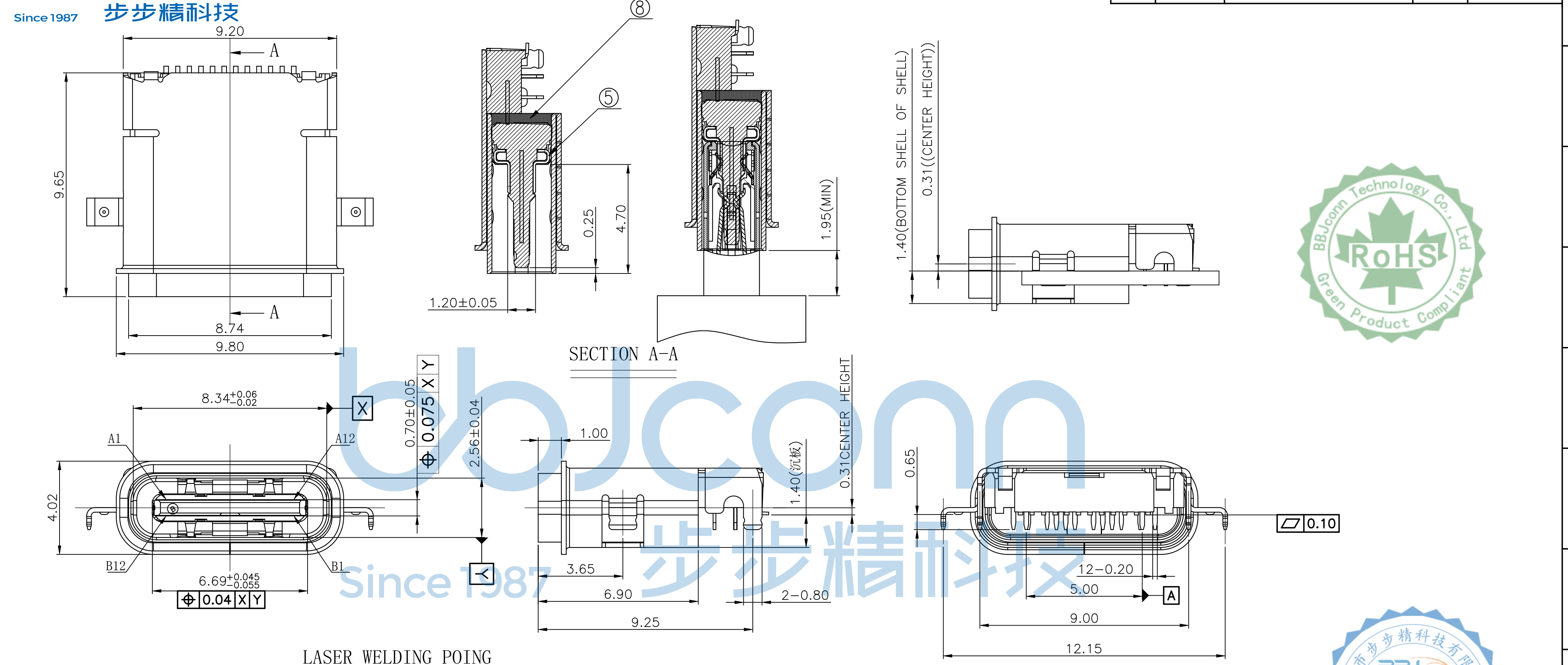
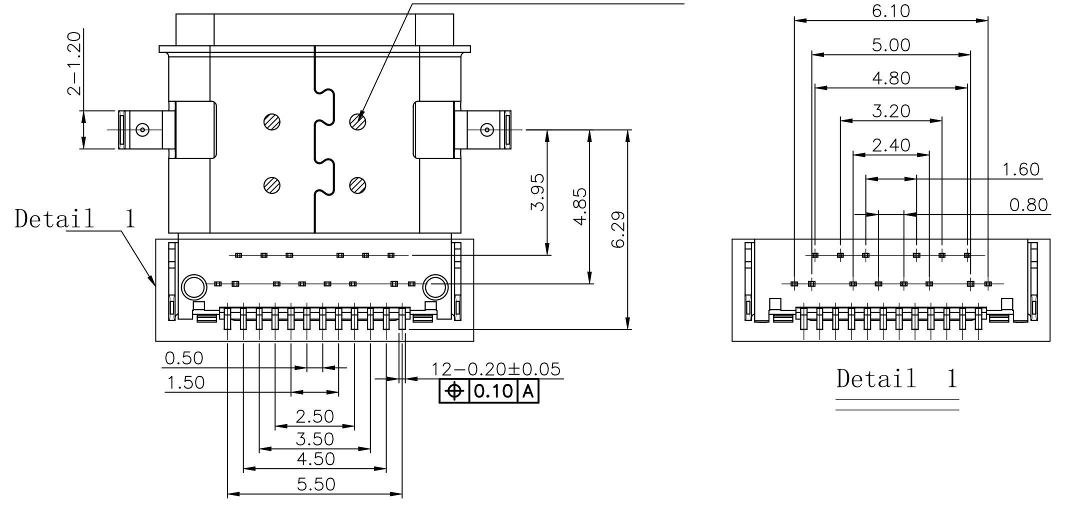
bbJconn
Since 1987 步步精科技

REV.	ECN NO.	CONTENT	DATE	ENGINEER
A0		Initial release	/	TSP



RoHS BBJconn Technology Co., Ltd Green Product Compliant

BBJconn APPROVED 工程部 深圳市步步精科技有限公司 BBJconn Technology Co., Ltd



THIS DOCUMENT IS THE SOLE PROPERTY OF BBJconn Technology Co.,Ltd. Corporation AND SHOULD NOT BE USED IN WHOLE OR IN PART WITHOUT PRIOR WRITTEN PERMISSION.

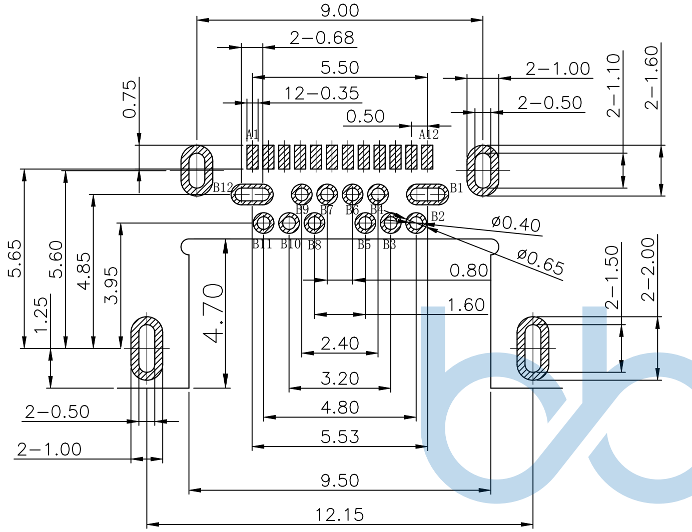
PDWG,NO: 0228-1

深圳市步步精科技有限公司

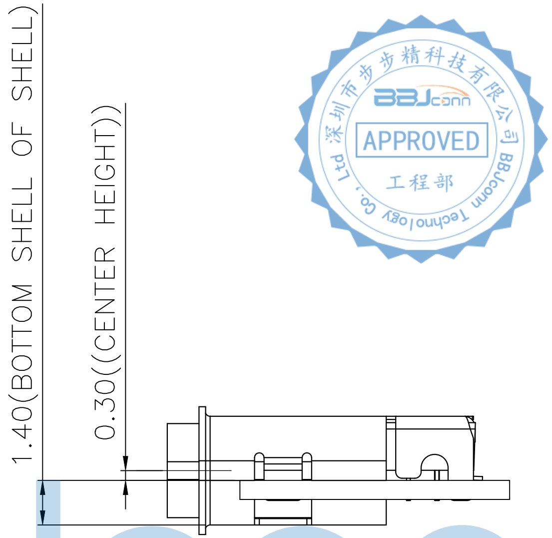
.X: ±0.38	X°: ±3°	NAME: TYPE-C 24P 母座 四脚插 双外壳 端子DIP+SMT 沉板1.4 L=9.65 CH=0.31 接触区镀金15U
.XX: ±0.25	.X°: ±2°	
.XXX: ±0.13	.XX°: ±1°	
APPD.	JM_Zheng	PJ. NO.: 126-223-240033-T7G
		SIZE: A4 DRW NO.:
CHKD.	LYX	FINISH: SEE NOTES · MAT'L.: SEE NOTES
DR.	TSP	SCALE: N/A · REV.: A0 · UNIT: mm · PAGE: 1/4

bbJconn
Since 1987 步步精科技

REV.	ECN NO.	CONTENT	DATE	ENGINEER
A0		Initial release	/	TSP



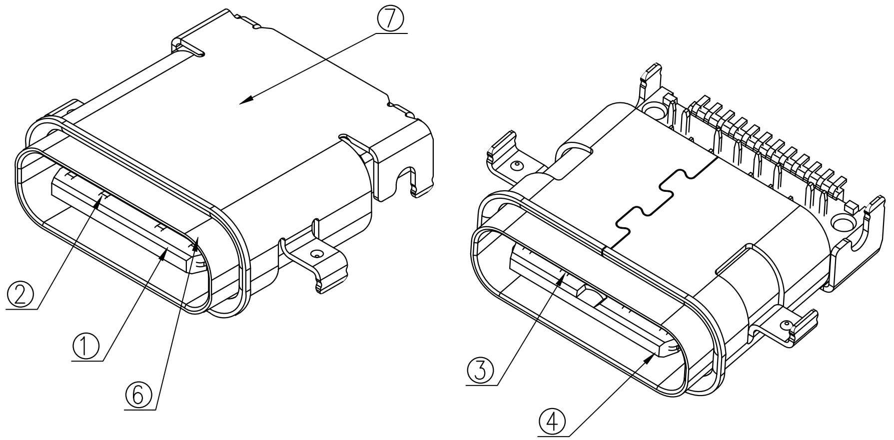
RECOMMENDED P.C.B LAYOUT(Both sides are sample)
Tolerance:±0.05,Thickness=0.60mm



1. MATERIAL:
   MOLDING: LCP UL94 V-0
   CONTACT:COPPER ALLOY.
   G/F PLATED GOLD ON CANTACT AREA,
   15u" GOLD ON SOLDER AREA,
   50u" NICKEL PLATING OVER ALL.
   SHELL: SUS304-H, T=0.30±0.03mm
   50u" NICKEL PLATING OVER ALL.
   EMI SHILD:SUS304-H, T=0.12±0.03mm
   LATCH:SUS301-H, T=0.15±0.03mm
2. MECHANICAL:
   INSERTION: 5~20N.
   EXTRACTION: 8~20N.
   DURABILITY: 10000 CYCLES
3. ELECTRICAL:
   CURRENT: 5A MAX FOR VBUS;
   1.25A MAX FOR OTHER.
   VOLTAGE: 20VDC MAX
   WITHSTANDING VOLTAGE: 100V AC.
   CONTACT RESISTANCE: 40mΩ MAX.
   INSULATION RESISTANCE: 100MΩ MIN.
4. ENVIRONMENTAL
   TEMPERATURE RANGE: -30° C TO +80° C

深圳市步步精科技有限公司 BBJconn APPROVED 工程部 Technology Co., Ltd

BBJconn Technology Co., Ltd RoHS Green Product Compliant



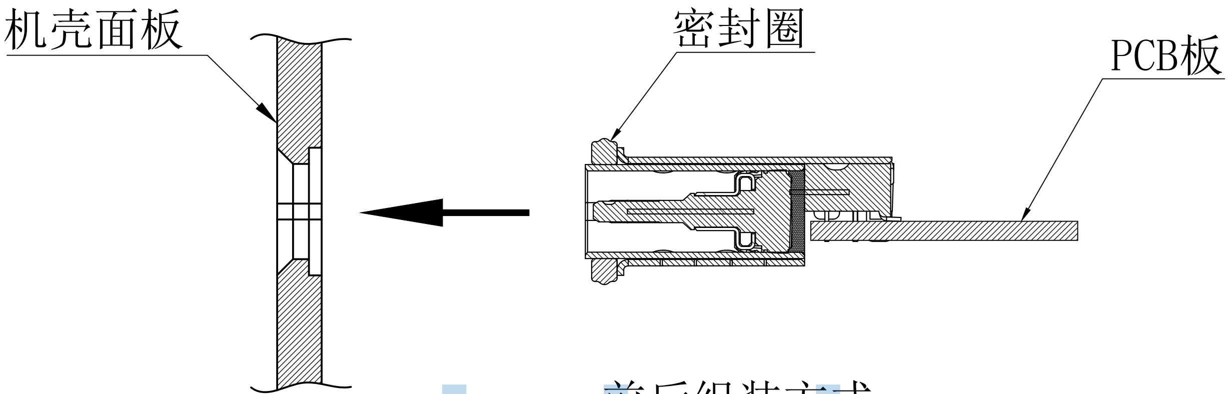
PDWG,NO: 0228-1

深圳市步步精科技有限公司

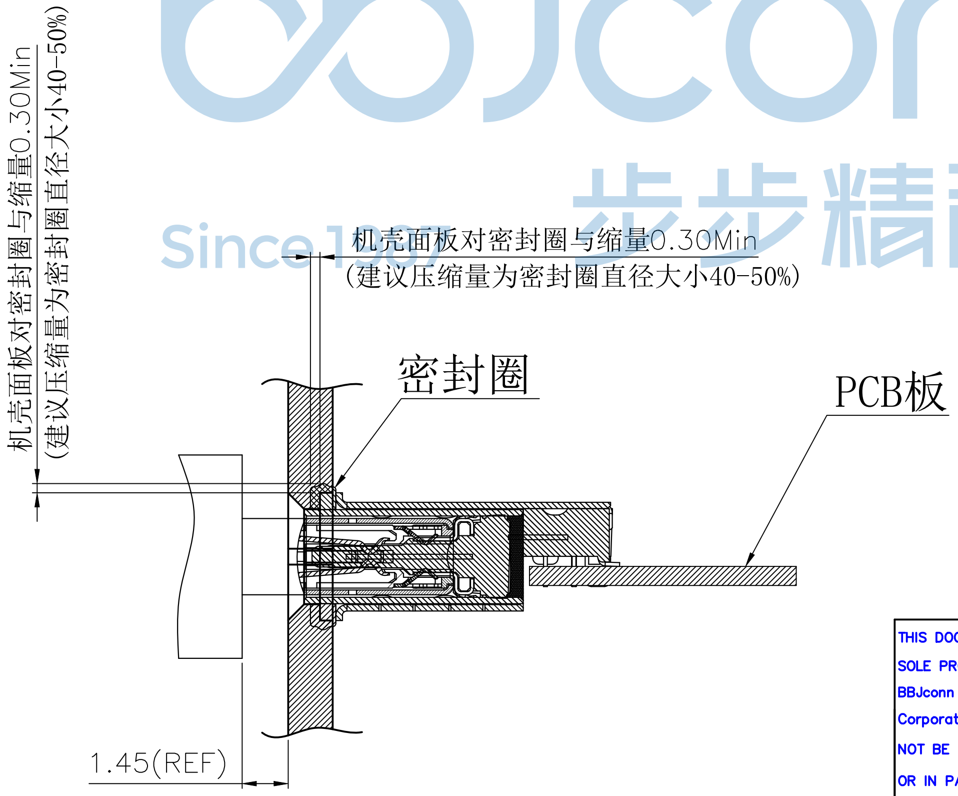
.X: ±0.38	X°: ±3°	NAME: TYPE-C 24P 母座 四脚插 双外壳 端子DIP+SMT 沉板1.4 L=9.65 CH=0.31 接触区镀金15U	
.XX: ±0.25	.X°: ±2°		
.XXX: ±0.13	.XX°: ±1°		
APPD.	JM_Zheng	PJ. NO.: 126-223-240033-T7G	
		SIZE: A4	DRW NO.:
CHKD.	LYX	FINISH: SEE NOTES	MAT'L.: SEE NOTES
DR.	TSP	SCALE: N/A REV.: A0	UNIT: mm PAGE: 2/4

建议密封方式

REV.	ECN NO.	CONTENT	DATE	ENGINEER
A0		Initial release	/	TSP



前后组装方式



组装面板后公母头对插示意图

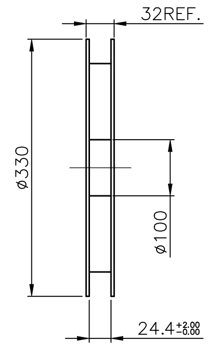
PDWG,NO: 0228-1

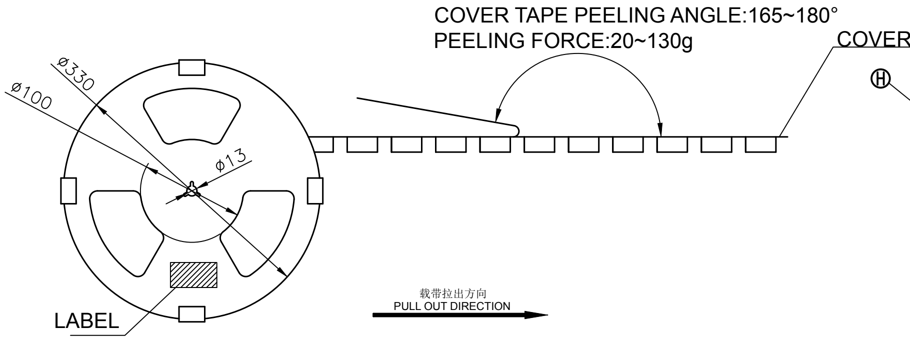
深圳市步步精科技有限公司

.X: ±0.38	X°: ±3°	NAME:	TYPE-C 24P 母座 四脚插 双外壳 端子DIP+SMT 沉板1.4 L=9.65 CH=0.31 接触区镀金15U
.XX: ±0.25	.X°: ±2°		
.XXX: ±0.13	.XX°: ±1°		
APPD.	JM_Zheng	PJ. NO.:	126-223-240033-T7G
		SIZE: A4	DRW NO.:
CHKD.	LYX	FINISH: SEE NOTES	MAT'L.: SEE NOTES
DR.	TSP	SCALE: N/A REV.: A0	UNIT: mm PAGE: 3/4

bbJconn
Since 1987 步步精科技

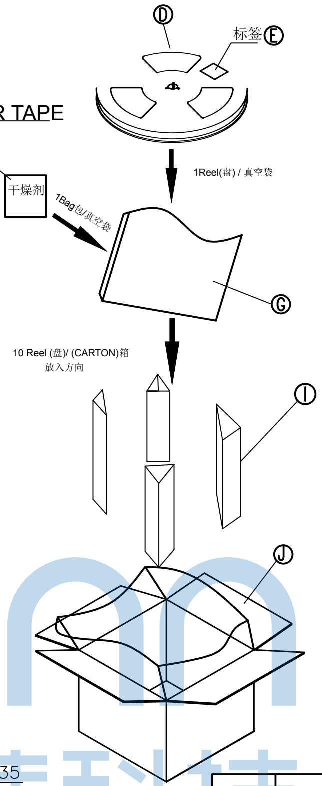
REV.	ECN NO.	CONTENT	DATE	ENGINEER
A0		Initial release	/	TSP

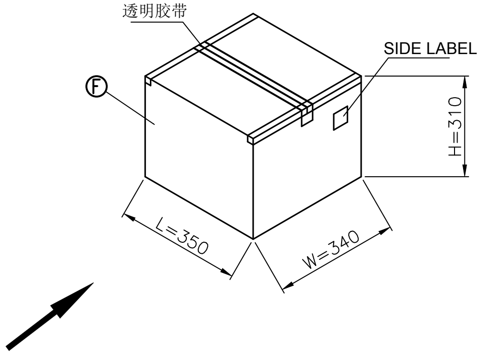




COVER TAPE PEELING ANGLE:165~180°
PEELING FORCE:20~130g
COVER TAPE

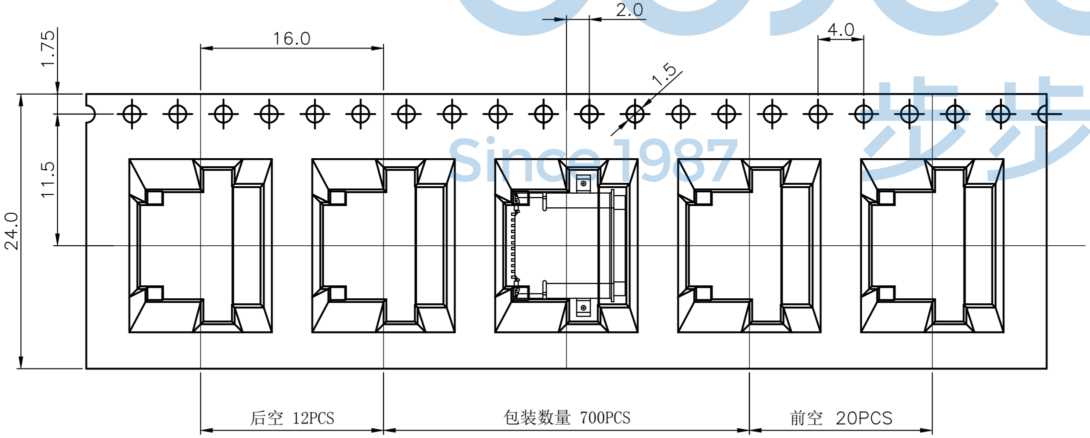
载带拉出方向
PULL OUT DIRECTION

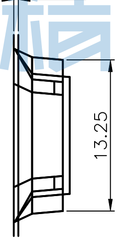




防水胶圈包装(两者独立包装)

5000	6	30000
PCS/BAG	BAG/CASE	PCS/CASE





NO	DESCRIPYION	Q'TA(PCS)	SPEC
J	PE袋	1	630L*620W
I	三角护柱	4	
H	干燥剂	10	
G	真空袋	10	500L*450W
F	纸箱	1	350L*340W*310H
E	标签	10	
D	REEL	10	
C	COVER TAPE	10	21.3m/m (1R/300M)
B	CARRIER TAPE	10	12511(L)*24(W)*0.4(T)
A	Phone Jack	7000	U501T24J4FZL2

深圳市步步精科技有限公司 BBJconn Technology Co., Ltd
APPROVED
工程部

BBJconn Technology Co., Ltd
RoHS
Green Product Compliant

THIS DOCUMENT IS THE SOLE PROPERTY OF BBJconn Technology Co.,Ltd. Corporation AND SHOULD NOT BE USED IN WHOLE OR IN PART WITHOUT PRIOR WRITTEN PERMISSION.

PDWG,NO: 0228-1

深圳市步步精科技有限公司

.X: ±0.38	X°: ±3°
.XX: ±0.25	.X°: ±2°
.XXX: ±0.13	.XX°: ±1°

NAME: TYPE-C 24P 母座 四脚插 双外壳 端子DIP+SMT 沉板1.4 L=9.65 CH=0.31 接触区镀金15U

APPD.	JM_Zheng	PJ. NO.: 126-223-240033-T7G	
		SIZE: A4	DRW NO.:
CHKD.	LYX	FINISH: SEE NOTES	MAT'L.: SEE NOTES
DR.	TSP	SCALE: N/A REV.: A0	UNIT: mm PAGE: 4/4